507200912 03/28/2022

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7247762

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
SEQUENCE:	9

CONVEYING PARTY DATA

Name	Execution Date
DOW CHEMICAL PACIFIC (SINGAPORE) PRIVATE LIMITED	05/18/2018

RECEIVING PARTY DATA

Name:	DOW GLOBAL TECHNOLOGIES LLC
Street Address:	2040 DOW CENTER
City:	MIDLAND
State/Country:	MICHIGAN
Postal Code:	48674

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16624177

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 9896331963

Email: FGLMFRR@DOW.COM

Correspondent Name: BARB PROSS

Address Line 1: 2211 H.H. DOW WAY

Address Line 4: MIDLAND, MICHIGAN 48674

ATTORNEY DOCKET NUMBER:	80937-US-PCT
NAME OF SUBMITTER:	BARB PROSS
SIGNATURE:	/Barb Pross/
DATE SIGNED:	03/28/2022

Total Attachments: 2 source=80937 9#page1.tif source=80937 9#page2.tif

PATENT 507200912 REEL: 059516 FRAME: 0639

ASSIGNMENT

(with Priority Rights)

INVENTORSHIP DECLARATION

We, ASSIGNOR, of:

DOW CHEMICAL PACIFIC (SINGAPORE) PRIVATE LIMITED
260 Orchard Road

18-01 The Heeren Singapore 238855 Republic of Singapore

on entity organized and existing under the laws of REPUBLIC OF SINGAPORE do hereby claim and declare that we hold the investion and all patent and other rights and powers obtainable or exercisable in respect thereof from the sole, true and first inventor(s).

Edward L. Lee, 24 Tuss South Street 3, Singapore 638025, Republic of Singapore

by an Assignment dated. October 20, 2017 of an invention relating to and entitled

LOW TEMPERATURE MULTILAYER SHRINK FILMS, AND METHODS OF MAKING THEREOF

We do hereby declare, for good and valuable consideration, precived, self, essign, and transfer upon

WE, the ASSIGNEE:

DOW GLOBAL TECHNOLOGIES LLC

2040 Dow Center

Midland, Michigae 48674 United States of America

an onlity argustized and existing under the laws of the State of Delaware, United States of America our entire right, title and interest throughout the world, in and to the invention and all rights and powers to make application for Letters Patest in its own name, or in the name of its nominee, and all rights and powers to file any reissue, divisional, continuing or substitute application and any corresponding applications in any and all countries, including all rights to claim priority under all loternational Conventions and Treaties in the name of said Assignee, and to hereby authorize said Assignee to insert here the Priority Number, Filing Date, and Filing Country.

of the application on which the priority will be based, and in and to any Letters Patent that may be issued for said invention in any and all countries, and we do hereby agree to assist each Assignee in the prosecution of the said applications and is any interference, conflict, apposition or litigation which may arise involving said invention or the patent or patents thereon, and to execute any reissue, divisional, continuing or substitute application and assent to their making any applications in other countries corresponding to the above and below specifically identified application, as may be requested by said Assignee; and we do hereby authorize said Assignee to insert here the corresponding Application Number, Filing Date, and Filing Country.

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of the corresponding application in any country where that patent property must be entered for recordal of this Assignment, and we do hereby authorize and request that any such Letters Patent be issued to said Assignee in accordance herewith, and crossent to the recordal of this Assignment being under covenant, not only that we have full power to make the same, but also that such assigned rights are not encumbered by any gram, license, or other right heretofore given.

lint such assigned rights	are not encumbered by	any gram, license,	or other right he	retofore given		
Subscribed and Swom b	y us at <u>260 Orchard</u>	Road, #18-01	The Heeren	Singapore 2	38855	
this 18th day of	May	, 20 18				
		IW CHEMIC MITED	AL PACIFI	. (SINGAP)	JRE) PRI	VATE
CORF SEAL		dun	MM	m		
	•	TAN SU-MIN	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	7./		

DIRECTOR

PATENT REEL: 059516 FRAME: 0640

ASSIGNEE ACCEPTANCE

WE, the ASSIGNEE:

BOW GLOBAL TECHNOLOGIES LLC

2040 Dow Center

Midiand, Michigan 48674 United States of America

bereby accept the ASSIGNMENT which is dated: May 18, 2018

From, the ASSIGNOR:

DOW CHEMICAL PACIFIC (SINGAPORE) PRIVATE LIMITED

260 Orchard Road 18-01 The Heeren Singapore 238855 Republic of Singapore

of the invention entitled:

LOW TEMPERATURE MULTILAYER SHRINK FILMS, AND METHODS OF MAKING THEREOF

without any restrictions and with all rights and obligations deriving therefrom and declare that this confirmation of acceptance shall be deemed a part of the said ASSIGNMENT.

Signed at	Midland, Michiga	n 48674, USA		
this ZS4A	dayof VVa	u	. 20 18	
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		SPÉVE W. I		
		Authorized I	Representative	

PATENT REEL: 059516 FRAME: 0641

RECORDED: 03/28/2022